

**HIGH POWER DIODE MODULE TYPE  
40A / 2200V**

Preliminary

**Features**

- High Surge Capability
- Type 2200V  $V_{RRM}$
- Isolation Type Package
- Electrically Isolation base plate

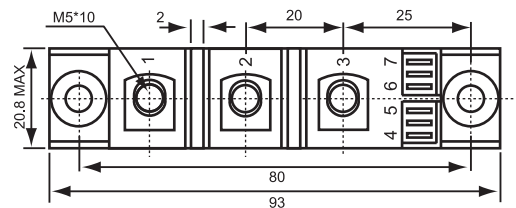


**Maximum Ratings**

Operating Temperature : -40 °C to +150 °C  
Storage Temperature : -40 °C to +150 °C

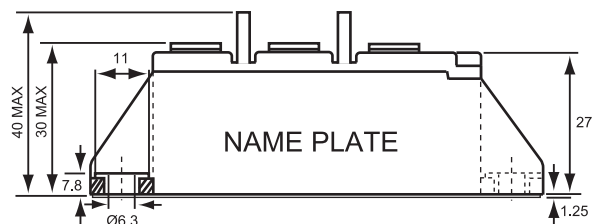
Part Number	Maximum Recurrent Peak Reverse Voltage	Maximum DC Blocking Voltage
MSRTTA40220A(R)	2200V	2200V

Dimensions in mm (1 mm = 0.0394")

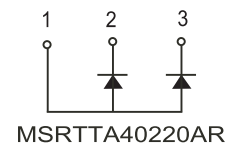
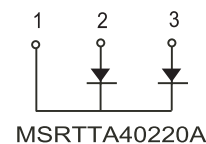


**Electrical Characteristics @ 25 °C Unless Otherwise Specified**

Item	Symbol	Rating		Conditions
		Max		
Average Forward Current (Per pkg)	$I_{F(AV)}$	40 A		$T_c = 140^\circ\text{C}$
Peak Forward Surge Current (Per leg)	$I_{FSM}$	1080A		8.3ms, half sine
Isolation Voltage	$V_{iso}$	3000 V		A.C. 1 minute
Mounting torque		5 ± 0.5Nm 3 ± 0.5Nm		to heatsink to terminals



Item	Symbol	Rating		Conditions
		Typ.	Max	
Maximum (Per leg) Instantaneous Forward Voltage *	$V_F$	0.87V 0.92V	0.98V 1.05V	$I_{FM} = 10 \text{ A}; T_J = 25^\circ\text{C}$ $I_{FM} = 20 \text{ A}; T_J = 25^\circ\text{C}$
Maximum Instantaneous Reverse Current At Rated DC Blocking Voltage (Per leg)	$I_R$		25 uA 3 mA	$T_J = 25^\circ\text{C}$ $T_J = 150^\circ\text{C}$
Maximum Thermal Resistance Junction To Case (Per leg)	$R_{\theta jc}$		0.6°C/W	



NOTE :

(1) Pulse Test: Pulse Width 300 μ sec. Duty Cycle < 2%

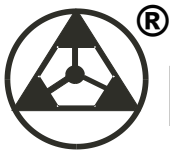


Figure .1 - Typical Forward Characteristics

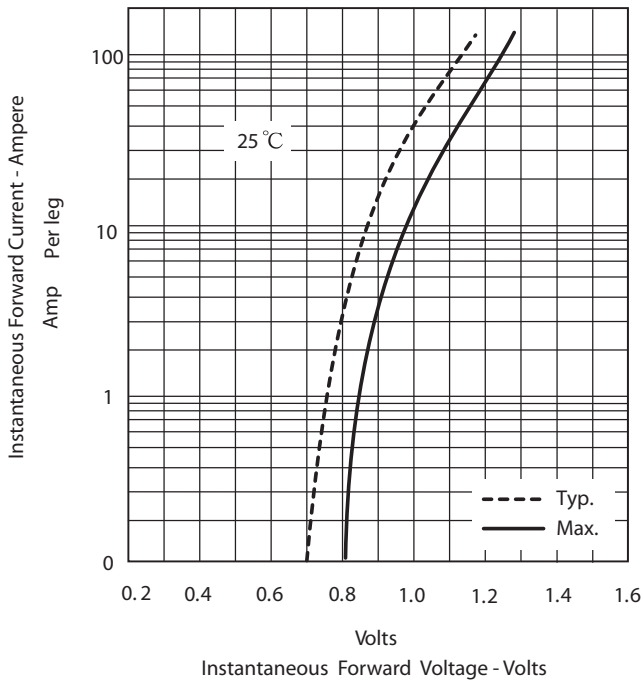


Figure.2 - Forward Derating Curve

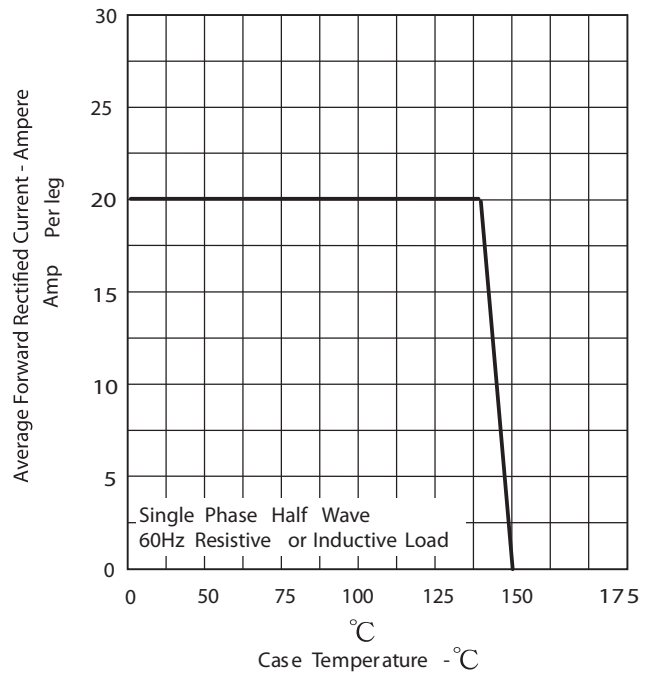


Figure.3 - Peak Forward Surge Current

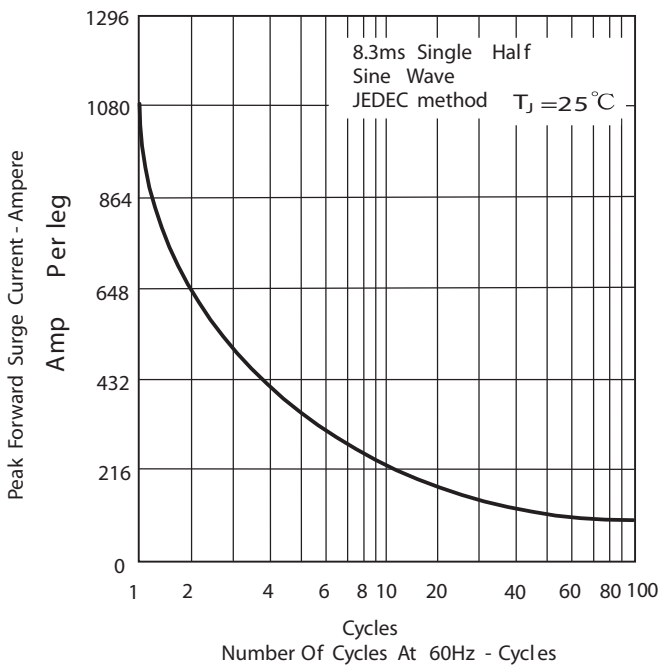
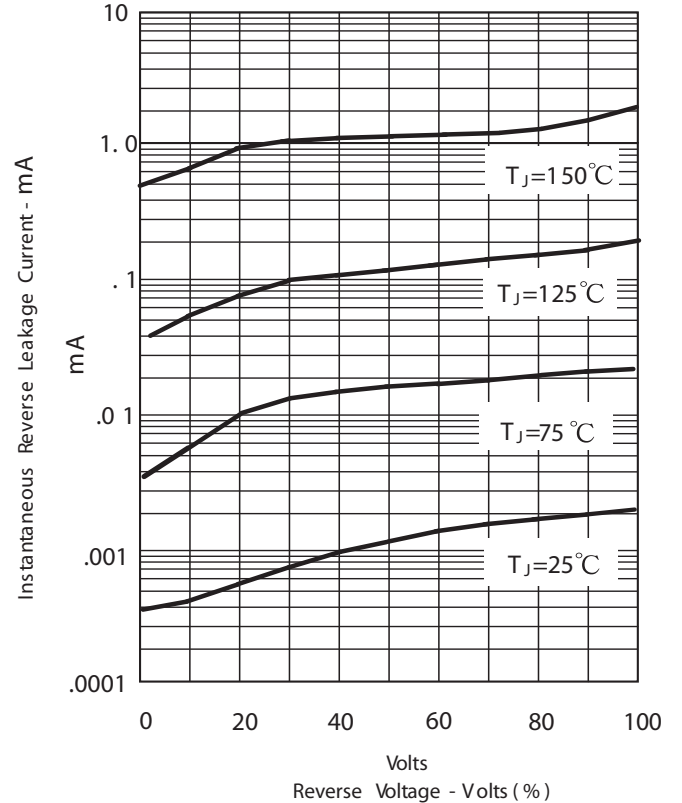


Figure .4 -Typical Reverse Characteristics





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